

# APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	[METHOD OF FABRICATING THIN FILM TRANSISTOR ARRAY SUBSTRATE AND STACKED THIN FILM STRUCTURE]
Application Type :	regular, utility
Attorney Docket Number :	12406-US-PA
Correspondence address:	
Customer Number:	31561
	
Priority Data:	
Doc.No: 93105043; Country -TW ; Date: 2004-02-27 us-priority-claimed	
Inventor Information:	
<u>Inventor 1:</u>	
<b>Applicant Authority Type:</b>	Inventor
<b>Citizenship:</b>	TW
<b>Name prefix:</b>	Mr.
<b>Given Name:</b>	Han-Chung
<b>Family Name:</b>	Lai
<b>Residence:</b>	
<b>City of Residence:</b>	Taoyuan Hsien
<b>Country of Residence:</b>	TW
<b>Address-1 of Mailing Address:</b>	No. 20, Alley 63, Lane 122, Chengkung Rd.,
<b>Address-2 of Mailing Address:</b>	Chungli,
<b>City of Mailing Address:</b>	Taoyuan Hsien
<b>State of Mailing Address:</b>	
<b>Postal Code of Mailing Address:</b>	
<b>Country of Mailing Address:</b>	TW
<b>Phone:</b>	
<b>Fax:</b>	
<b>E-mail:</b>	
Attorney Information:	
practitioner(s) at Customer Number:	

31561



as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.